

	广州亨	『 光电子有》	艮公司
Gua	angzhou H	leng Guang Electr	onics Co.,Ltd
SP	ECIFIC	ATION FOR A	PPROVAL
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	圩	K 认 =	书
SUSTOMER'S CODE 客户代码			
DESCRIPTION 品名	大功率发	光管	
SPECIFICATION			
规格	3535 白ナ	ť	
DATE 送样日期			
PART NO. 本厂型号	HG-W40S1	12-3535-AT7	
REFERENCE NO.		12 0000 MT	
档案号			
NUMBER OF SAMP 送样数量	PCS	COPY OF ACKNOWLED 承认书份数	
	ustomer	Qualified By	Form Designer 制作
Approved By Cu 客户承i	人	核 准	



HG-W40S12-3535-AT7

Top LED

Part Number	(Chip		
Part Number	Material	Source Color	Lens Color	
HG-W40S12-3535- AT7	InGaN	White	Water Clear	



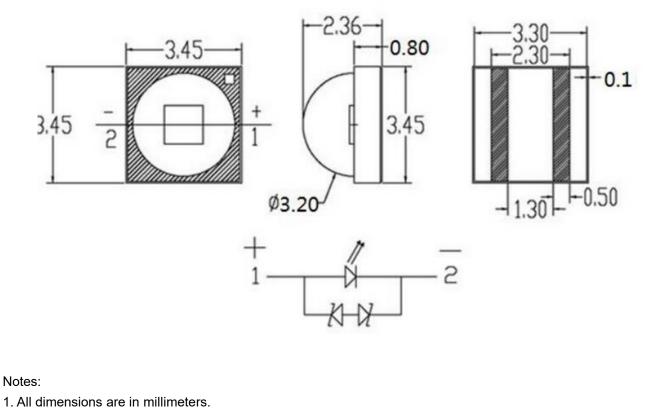
OBSERVE PRECAUTIONS FOR HANDLING

ELECTROSTATIC SENSITIVE DEVICES

Features

- High brightness white LED round package
- Light output intensity grade Viewing angle 120 degree
- Light color. white
- RoHS compliant

Dimensions



2. Tolerance is ±0.1mm unless otherwise noted



Absolute Maximum Rating @ Ta=25°C

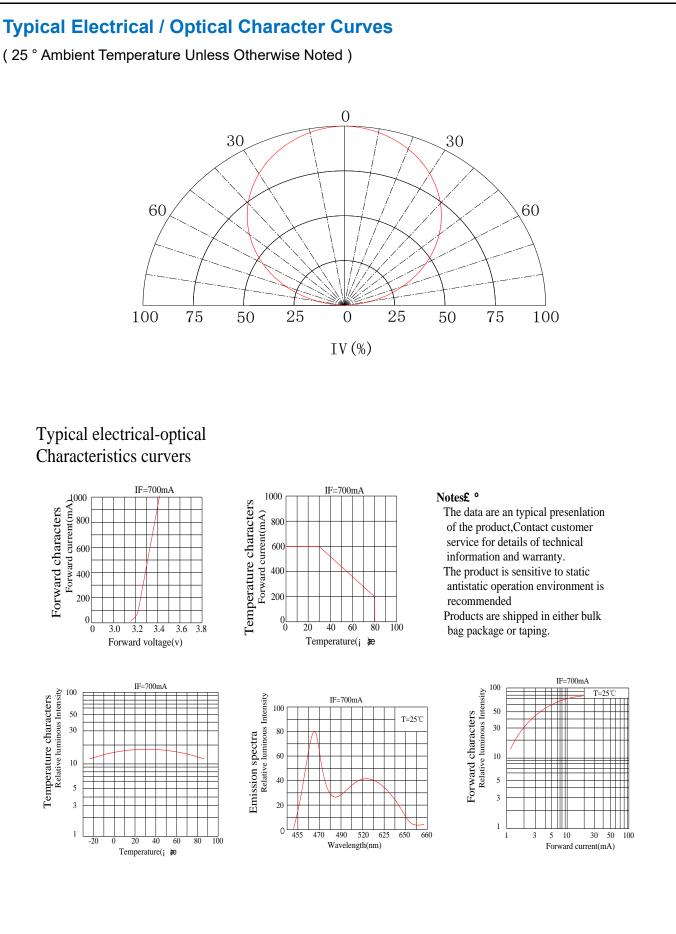
Parameter	Symbol	Maximum Rating	Unit
Continuous Forward Current	IF	700	mA
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFp	1000	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	3	W
Electrostatic discharge	ESD	1000	V
Operating Temperature Range	TOPR	-25°C to +85°C	
Storage Temperature Range	TSTG	-35°C to +105°C	
Lead Soldering Temperature (3mm from tne base of the epoxy bulb)	TSOL	360°C	

Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Forward Voltage	VF	3.2	3.4	3.6	V	I _F =700mA
Light intensity	Φ	200	220	240	LM	I _F =700mA
Ohusmatisistu Osaudinataa	x		031		١	I _F =700mA
Chromaticicty Coordinates	у		0.32		١	I _F =700mA
Color Temperature	Тс	6000	7000	8000	К	I _F =700mA
Reverse Current	IR	0		10	μA	V _R =5V
Viewing Angle	201/2		120		deg	I _F =700mA
Recommend Forward Current	IF(rec)			700	mA	

tolerance of measurement of forward voltage $\pm 0.1 V$







Тур е	Test Item	REF Standard	Test Condition	Note	Number of Damaged
Environme	Temperature Cycle	JIS C 7021 (1997)A-4	-20°C*30mins~25°C *5mins~ 80°C * 30mins	100 cycles	0/100
Environmental Sequence	High Humidity Heat Cycle	JIS C 7021 (1997)A-5	30°C→65°C, RH= 90% 24hrs/1cycle	10 cycles	0/100
ĕ	High Temperature Storage	JIS C 7021 (1997)B-10	Ta= 80°C	1000h	0/100
	Humidity Heat Storage	JIS C 7021 (1997)B-11	Ta=60°C RH=90%	1000h	0/100
	Low Temperature Storage	JIS C 7021 (1997)B-12	Ta= -30°C	1000h	0/100
Operati	DC Operating Life	JIS C 7035 (1985)	Ta= 25°C, IF=700mA	1000h	0/100
Operation Sequence	High Humidity Heat Life Test	*	Ta=60°C RH=90% IF=700mA	500h	0/100
nce	Low Temperature Life Test	*	Ta= -20°C, IF=700mA	1000h	0/100
Destructive Sequence	Resistance to Soldering Heat	JIS C 7021 (1997)A-11	Tsol=260 \pm 5 $^{\circ}$ C,10sec (3mm from the base of the epoxy bulb)	1 time	0/20
	Solderability	JIS C 7021 (1997)A-2	Tsol=235 \pm 5 $^{\circ}$ C,5sec (Using flux)	1 time (over 95%)	0/20
	Lead Pull/Bend Test	JIS C 7021 (1997)A-11	Load 2.5N (0.25kgf) 0° → 90° →0° Bending 3 times	No noticeable damage	0/20



Cautions

The LED's are devices which are materialized by combining blue LED's and special phosphors. Consequently the color of the LED's is changed a little by an operating current. Care should be taken after due consideration when using LED's.

(1) Moisture Proof Package:

When moisture is absorbed into package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LED's. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.

(2) Storage Conditions

Before opening the package:

The LED's should be kept at 30°C or less and 60%RH or less. The LED's should be used with in a year. When storing the LED's. Moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package:

The LED's should be kept at 30°C or less and 50%RH or less. The LED's should be soldered within 168 hours (7days) after opening the package. If unused LED's remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LED's to the original moisture proof bag and to reseal the moisture proof bag again. If the moisture absorbent material (silica gel) has faded away or the LED's have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: more than 48 hours at 65±5°C HG LED electrode and lead free are comprised of a silver plated copper alloy .The silver surface may be affected by environments which contain corrosive gases and so on. Please Avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration might lower solderability or might affect on optical characteristics. Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

(3) Heat Generation

Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification. The operating current should be decided after considering the ambient maximum temperature of LED's.

(4) Cleaning

It is recommended that isopropyl alcohol be used as a solvent for cleaning the LED 's. when using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LED's because of worldwide regulations. Do not clean the LED's by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LED's depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LED's will occur °C

(5) Static Electricity

Static electricity or surge voltage damages the LED's. It is recommended that a wrist band or an anti-electrostatic



glove be used when handling the LED's. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LED's. When inspecting the final products in which LED's were assembled, it is recommended to check. Whether the assembled LED's are damaged by static electricity or not, it is easy to find static-damaged LED's by a light –on test or a VF test at a lower current (below 1mA is recommended). Damaged LED's will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LED's do not light at the low current. Criteria (Vf>2.0V at If=0.5mA)

(6) Others

Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LED's with matrix drive. The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly at the LED's with unaided eyes for more than a few seconds. Flashing lights have been known to cause discomfort in people, you can prevent this by taking precautions during use. Also, people should be cautions when using equipment that has had LED's incorporated into it. The LED's described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment , communications equipment, measurement instruments and household appliances) Consult HG sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobile, traffic control equipment, life support systems and safety devices). User shall not reverse engineer by disassembling or analysis of the LED's without having prior written consent from HG when defective LED's are found, the User shall inform HG directly before disassembling or analysis. The formal specifications must be exchanged and signed by both parties before large volume purchase begins. The appearance and specifications of the product may be modified for improvement without notice.